



**PATENT APPLICATION**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In the Application of

Ikuya MIYAZAWA

Group Art Unit: 1725

Application No.: 10/090,142

Examiner: L. Edmondson

Filed: March 5, 2002

Docket No.: 112155

For: SOLDERING METHOD, SOLDERING DEVICE, AND METHOD AND DEVICE OF  
FABRICATING ELECTRONIC CIRCUIT MODULE

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OCT 29 2003

GROUP 1700

**AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In reply to the July 7, 2003 Office Action, please consider the following:

**Amendments to the Claims** as reflected in the listing of claims; and

**Remarks.**

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